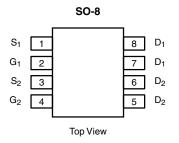




Vishay Siliconix

# Dual P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY							
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)				
- 40	0.027 at V <sub>GS</sub> = - 10 V	- 8	21.7 nC				
- 40	0.034 at V <sub>GS</sub> = - 4.5 V	- 7.2					



Ordering Information: Si4909DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

### **FEATURES**

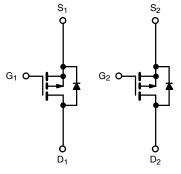
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- · Load Switches
  - Notebook PCs
  - Desktop PCs



P-Channel MOSFET P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 40	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		- 8.0		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 6.5		
Continuous Diain Curient (1 <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	- 6.4 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 5.1 <sup>a, b</sup>	^	
Pulsed Drain Current	I <sub>DM</sub>	- 30 <sup>e</sup>	A		
	T <sub>C</sub> = 25 °C		- 2.6		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 1.6 <sup>a, b</sup>		
Avalanche Current	1 04	I <sub>AS</sub>	- 20		
Single-Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C		3.2		
Manifestor Bassas Biodination	T <sub>C</sub> = 70 °C		2.1	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.0 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C		1.28 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	47	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	29	38	C/VV	

### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 110  $^{\circ}$ C/W.
- d. Based on  $T_C$  = 25 °C.
- e. Limited by package.

# Si4909DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•			, , , , , , , , , , , , , , , , , , ,			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$	- 40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 vA		- 34		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = - 250 μA		4.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
7 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	C -		- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 20			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 8 A		0.021	0.027		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		0.027	0.034	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 8 A		22		S	
Dynamic <sup>b</sup>					•		
Input Capacitance	C <sub>iss</sub>			2000		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		240			
Reverse Transfer Capacitance	C <sub>rss</sub>			202			
Total Gate Charge	0	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		41.5	63		
	Q <sub>g</sub>		21.7	33			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$		5.6		nC	
Gate-Drain Charge	$Q_{gd}$			9.8			
Gate Resistance	$R_g$	f = 1 MHz	1.5	6	12	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2 $\Omega$		9	18		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN} =$ - 10 V, $R_g = 1 \Omega$		50	90		
Fall Time	t <sub>f</sub>			13	26		
Turn-On Delay Time	t <sub>d(on)</sub>			42	75	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2 $\Omega$		40	70		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		40	70		
Fall Time	t <sub>f</sub>			18	35		
<b>Drain-Source Body Diode Characterist</b>	ics				•		
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.6	^	
Pulse Diode Forward Current	I <sub>SM</sub>				- 30	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			41	80	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = -2 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 \text{ °C}$		32	65	nC	
Reverse Recovery Fall Time				15			
Reverse Recovery Rise Time	t <sub>b</sub>			26		ns	

### Notes:

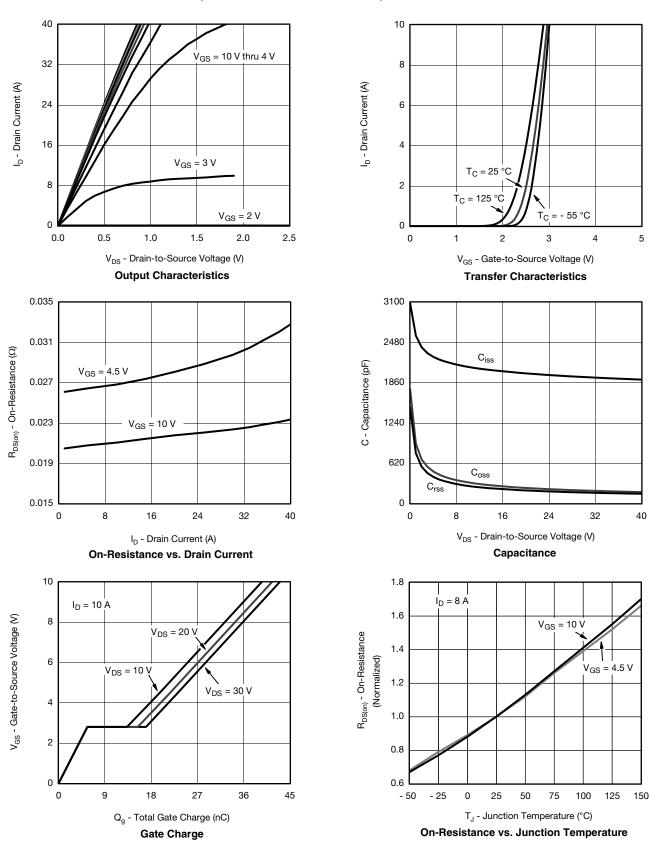
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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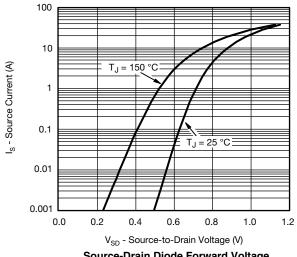
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



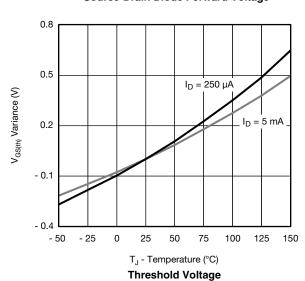
# Si4909DY

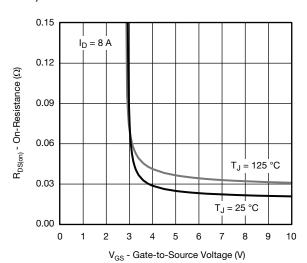
# Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

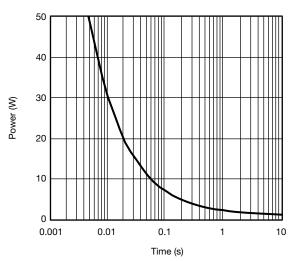


### Source-Drain Diode Forward Voltage

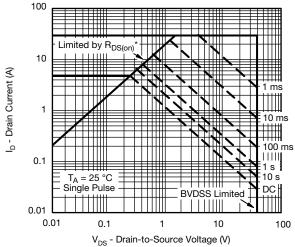




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



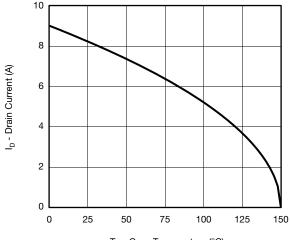
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area



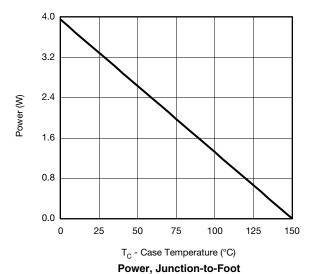
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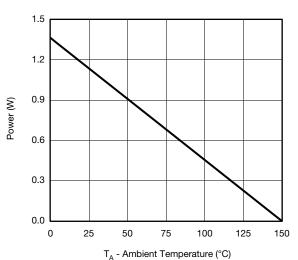
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



 $\rm T_{\rm C}$  - Case Temperature (°C)

### Current Derating\*





Power Derating, Junction-to-Ambient

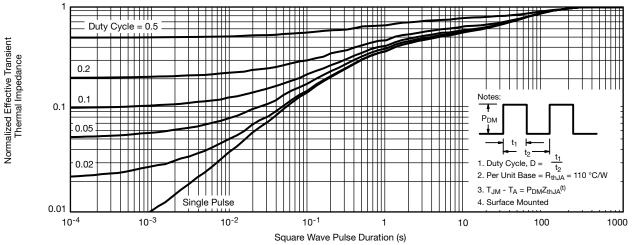
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

# Si4909DY

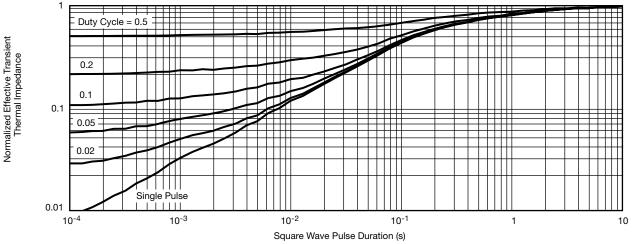
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppq?67077">www.vishay.com/ppq?67077</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

# LON NOTE



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000